

General Description

The MY8P035C uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

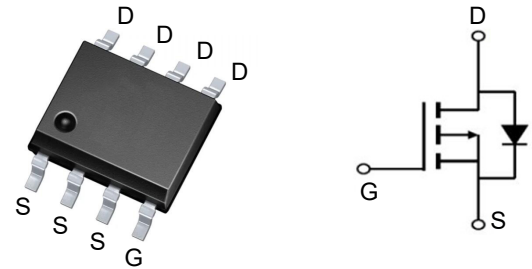


Features

V_{DSS}	-35	V
I_D	-8	A
$R_{DS(ON)}$ (at $V_{GS} = -10V$)	35	$m\Omega$
$R_{DS(ON)}$ (at $V_{GS} = -4.5V$)	42	$m\Omega$

Application

- Battery protection
- Load switch
- Uninterruptible power supply



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MY8P035C	SOP-8	null	3000

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0V$)	-35	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0V$)	± 20	V
I_D	Drain Current-Continuous($T_c=25^\circ\text{C}$)	-20	A
	Drain Current-Continuous($T_c=100^\circ\text{C}$)	-8	A
$I_{DM (pluse)}$	Drain Current-Continuous@ Current-Pulsed (Note 1)	-20	A
P_D	Maximum Power Dissipation($T_c=25^\circ\text{C}$)	37.5	W
	Maximum Power Dissipation($T_c=100^\circ\text{C}$)	19	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 175	$^\circ\text{C}$
R_{JC}	Thermal Resistance, Junction-to-Case	4	$^\circ\text{C/W}$

Electrical Characteristics (T_A=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =-250μA	-40			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-32V, V _{GS} =0V			-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1	-2	-3	V
g _{FS}	Forward Transconductance	V _{DS} =-5V, I _D =-10A		25		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-20A		35	46	mΩ
		V _{GS} =-4.5V, I _D =-10A		42	52	mΩ
C _{iss}	Input Capacitance	V _{DS} =-25V, V _{GS} =0V, f=1.0MHz		840		pF
C _{oss}	Output Capacitance			92		pF
C _{rss}	Reverse Transfer Capacitance			60		pF
t _{d(on)}	Turn-on Delay Time	V _{GS} =-10V, V _{DS} =-20V, R _L =1.6, R _{GEN} =3		5		nS
t _r	Turn-on Rise Time			12		nS
t _{d(off)}	Turn-Off Delay Time			20		nS
t _f	Turn-Off Fall Time			4.5		nS
Q _g	Total Gate Charge	V _{GS} =-10V, V _{DS} =-20V, I _D =-15A		20		nC
Q _{gs}	Gate-Source Charge			2.5		nC
Q _{gd}	Gate-Drain Charge			4.5		nC
I _{SD}	Source-Drain Current(Body Diode)				-20	A
V _{SD}	Forward on Voltage	V _{GS} =0V, I _S =-20A			-1.2	V

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

Typical Electrical and Thermal Characteristics

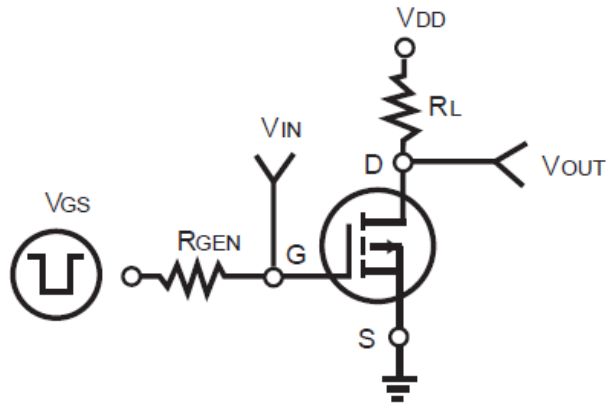


Figure1. Power Dissipation

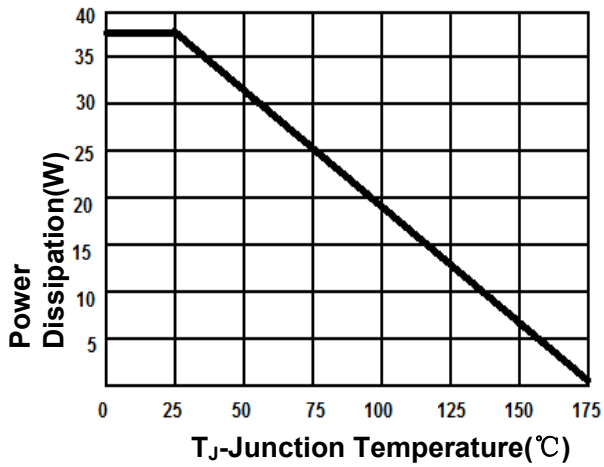


Figure3. Output Characteristics

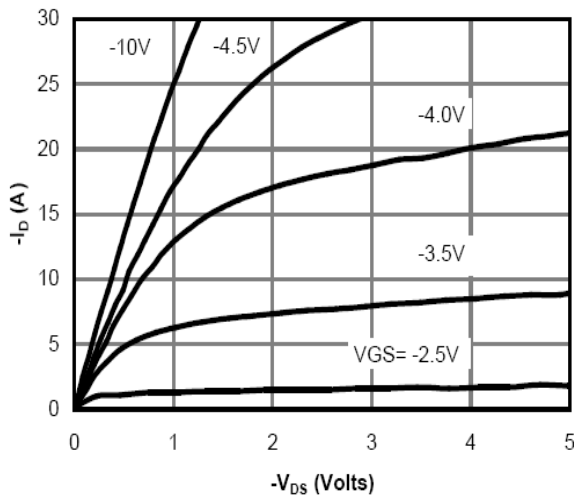


Figure5. Capacitance

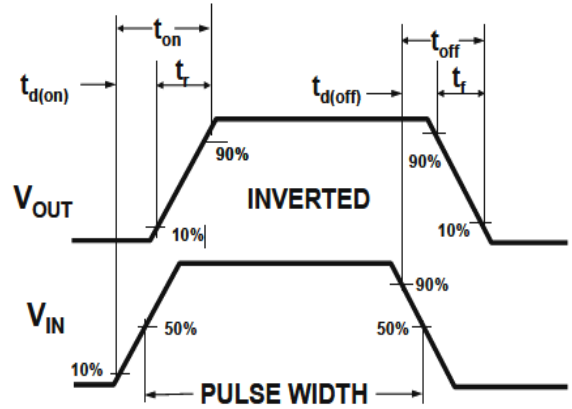


Figure2. Drain Current

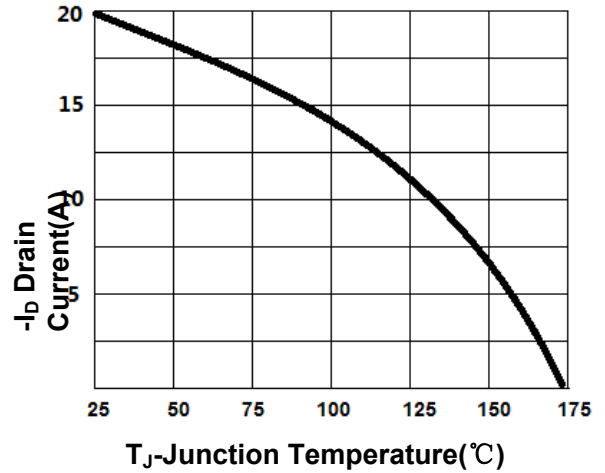


Figure4. Transfer Characteristics

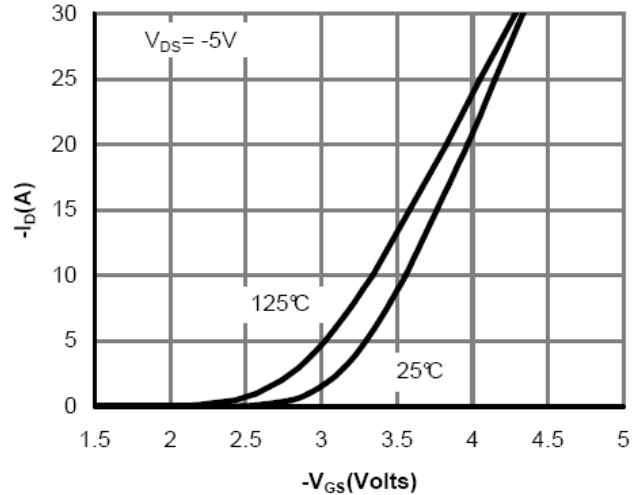


Figure6. R_{DS(ON)} vs Junction Temperature

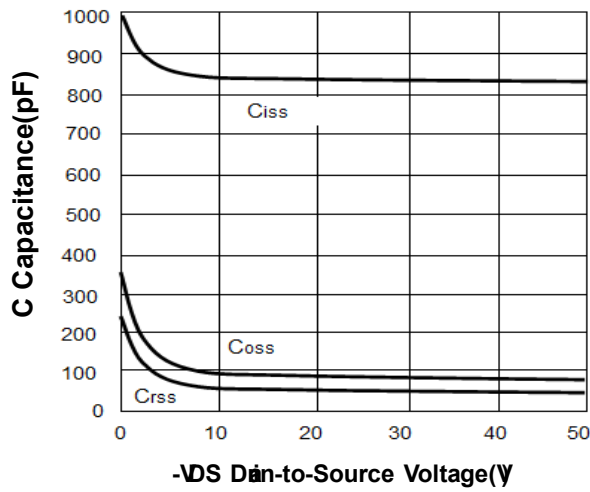


Figure7. $V_{GS(th)}$ vs Junction Temperature

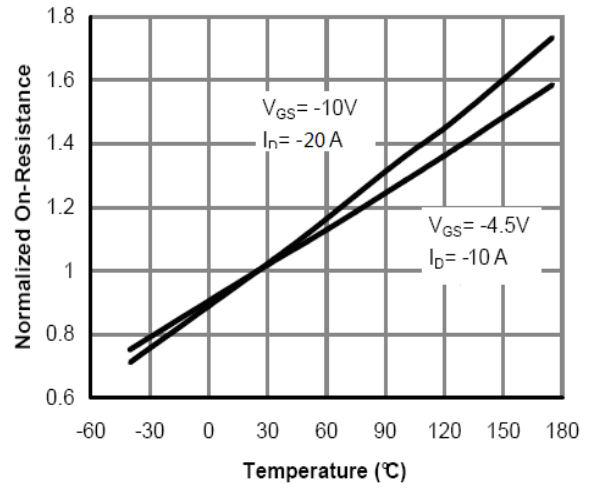


Figure8. Gate Charge Waveforms

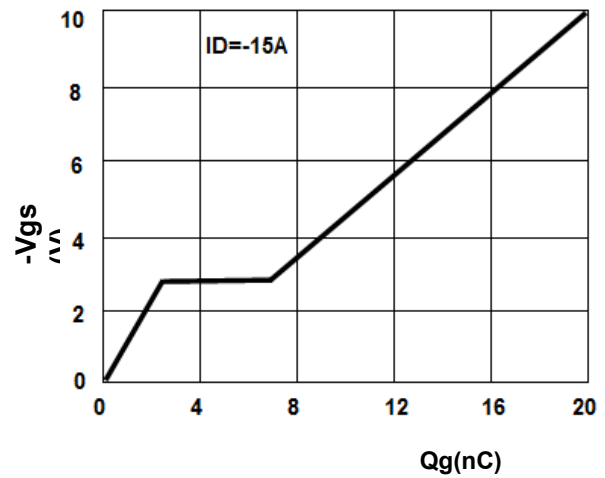
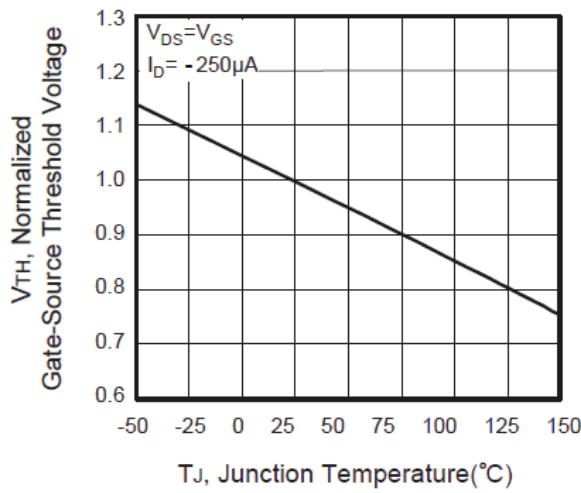
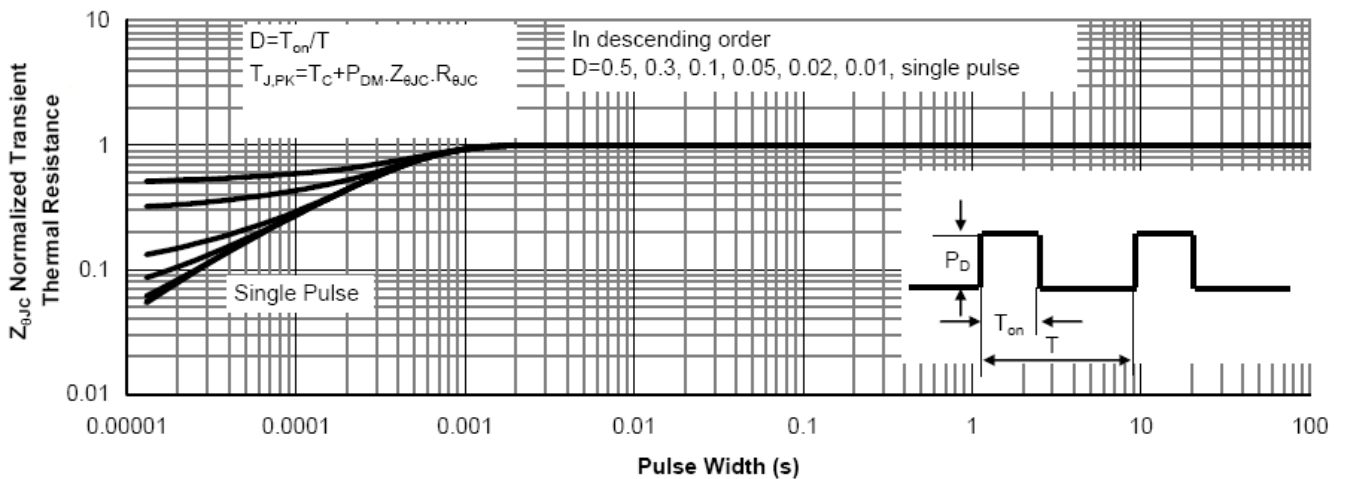
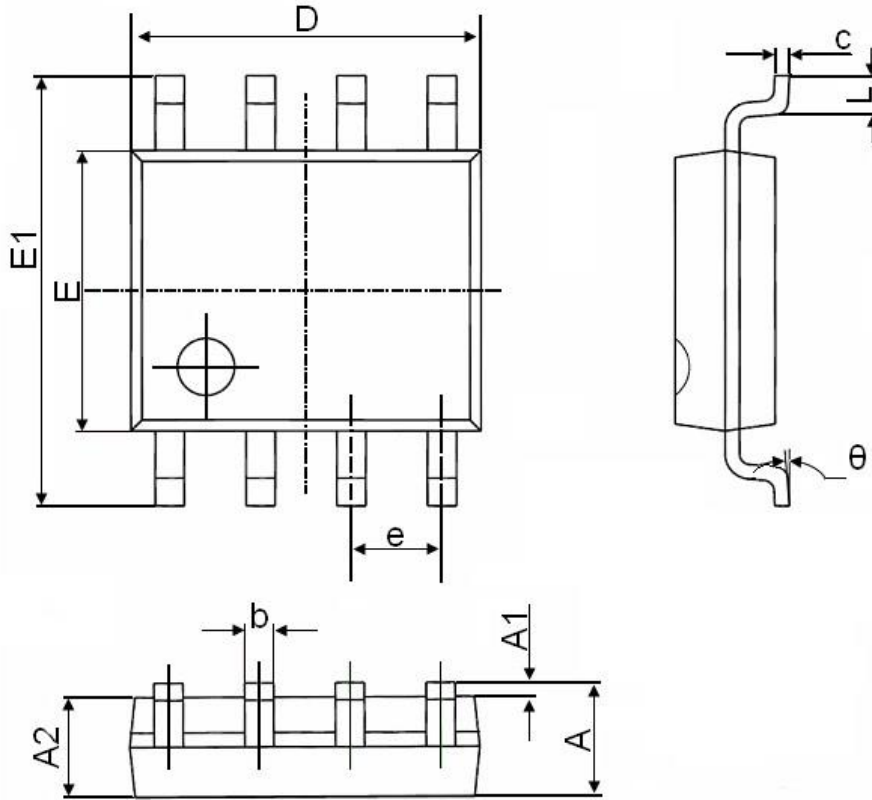


Figure9. Normalized Maximum Transient Thermal Impedance



Package Mechanical Data-SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050